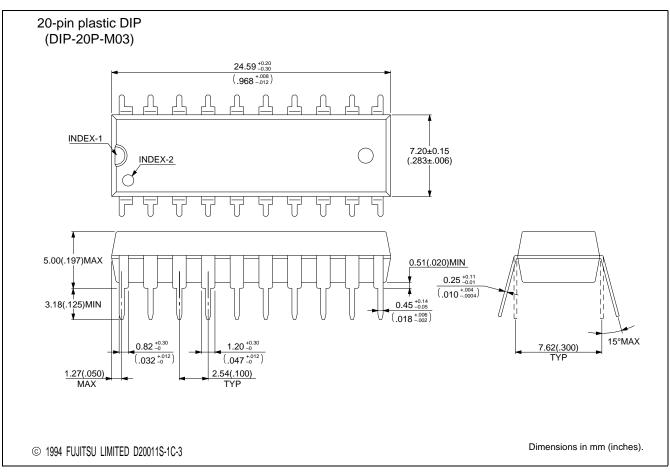
DIP-20P-M03

20-pin plastic DIP
Contraction of the second seco
(DIP-20P-M03)

Lead pitch	100 mil	
Row spacing	300 mil	
Sealing method	Plastic mold	



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EIAJ code :*DIP020-P-0300-3